

VALOX™ RESIN HX215HP

REGION AMERICAS

DESCRIPTION

Unreinforced PBT with mold release. For medical devices and pharmaceutical applications. Healthcare management of change, biocompatible (ISO 10993 OR USP Class VI), US FDA food contact compliant, gamma, e-beam, EtO sterilizable. Available in limited colors.

TYPICAL PROPERTY VALUES

Revision 20220721

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	60	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	26	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	3.7	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	10	%	ASTM D638
Tensile Modulus, 5 mm/min	2700	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	89	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2500	MPa	ASTM D790
Tensile Stress, yield, 50 mm/min	50	MPa	ISO 527
Tensile Stress, break, 50 mm/min	49	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	3.2	%	ISO 527
Tensile Strain, break, 50 mm/min	10	%	ISO 527
Tensile Modulus, 1 mm/min	2600	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	80	MPa	ISO 178
Flexural Modulus, 2 mm/min	2260	MPa	ISO 178
IMPACT			
Izod Impact, notched, 23°C	30	J/m	ASTM D256
Izod Impact, notched, -30°C	30	J/m	ASTM D256
Instrumented Dart Impact Total Energy, 23°C	20	J	ASTM D3763
Izod Impact, notched 80*10*4 +23°C	2	kJ/m ²	ISO 180/1A
Izod Impact, notched 80*10*4 -30°C	2	kJ/m ²	ISO 180/1A
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	6	kJ/m ²	ISO 179/1eA
THERMAL			
Vicat Softening Temp, Rate B/50	180	°C	ASTM D1525
HDT, 0.45 MPa, 3.2 mm, unannealed	150	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	54	°C	ASTM D648
CTE, -40°C to 40°C, flow	7.6E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	7.8E-05	1/°C	ASTM E831
CTE, -40°C to 40°C, flow	7.6E-05	1/°C	ISO 11359-2
CTE, -40°C to 40°C, xflow	7.8E-05	1/°C	ISO 11359-2
Vicat Softening Temp, Rate B/50	183	°C	ISO 306
Vicat Softening Temp, Rate B/120	180	°C	ISO 306
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	49	°C	ISO 75/Af
PHYSICAL			
Specific Gravity	1.31	-	ASTM D792

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Mold Shrinkage, flow, 3.2 mm	1.5 – 2	%	SABIC method
Melt Flow Rate, 250°C/2.16 kgf	80	g/10 min	ASTM D1238
Density	1.31	g/cm ³	ISO 1183
Water Absorption, (23°C/saturated)	0.34	%	ISO 62-1
Moisture Absorption (23°C / 50% RH)	0.08	%	ISO 62
Melt Volume Rate, MVR at 250°C/2.16 kg	70	cm ³ /10 min	ISO 1133
INJECTION MOLDING			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	12	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	245 – 260	°C	
Nozzle Temperature	240 – 255	°C	
Front - Zone 3 Temperature	245 – 260	°C	
Middle - Zone 2 Temperature	240 – 255	°C	
Rear - Zone 1 Temperature	230 – 250	°C	
Mold Temperature	50 – 75	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	50 – 100	rpm	
Shot to Cylinder Size	40 – 80	%	
Vent Depth	0.013 – 0.025	mm	
COMPOUNDING EXTRUSION			
Drying Temperature	110 – 120	°C	
Drying Time	4 – 6	Hrs	
Drying Time (Cumulative)	8	Hrs	
Maximum Moisture Content	0	%	
Melt Temperature	245 – 260	°C	
Barrel - Zone 1 Temperature	200 – 230	°C	
Barrel - Zone 2 Temperature	240 – 255	°C	
Barrel - Zone 3 Temperature	240 – 275	°C	
Barrel - Zone 4 Temperature	240 – 275	°C	
Adapter Temperature	240 – 275	°C	
Die Temperature	240 – 275	°C	
Waterbath Temperature	25 – 35	°C	

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